

Bill of Materials TI DESIGNS TIDM-RM46XDRV8301KIT DRV8301 EVM

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
	-			DIMP DDV000V HC COMOTOD DOADD			E4EE04 0004D		
1	1			PWB,DRV830X-HC-C2 MOTOR BOARD			515501-0001R		
2	1			LOGIC, DRV830X-HC-C2 MOTOR BOARD			515502-0001		
4	1	U7		IC,TSSOP16,TRANSLATOR,6-BIT BIDIRECTIONAL,VOLTAGE-LEVEL	Texas Instruments	TXB0106PWR	103742-0001R	pw16-14x70	
5	1	U1		IC,TSSOP56,THREE PHASE PRE-DRIVER	Texas Instruments	DRV8301DCA	103808-0001R		
7	2	U13, U9		IC,SOT23-5,OP AMP	Texas Instruments	OPA365AIDBVR	103805-0001R	dbv-20x60-5	
8	1			IC,SOIC,HIGH SPEED QUAD DIGITAL ISOLATORS,1Mbps	Texas Instruments	ISO7241ADW	103806-0001R	dw16-25x75-375	
9	1	U4		IC,SMT8,ISOLATED CAN TRANSCEIVER	Texas Instruments	ISO1050DUBR	103518-0001R	dub8-35x90	
10	1	U6		IC,DBV6,DUAL SCHMITT-TRIGGER BUFFER	Texas Instruments	SN74LVC2G17DBVR	103743-0001R	dbv6-27x39-6	
11	2	U3, U8		IC,DBV5,LDO REGULATOR,3.3V,400mA	Texas Instruments	TPS73633MDBVREP	103807-0033R	dbv-20x60-5	
12	1	U2		POWER MODULE,5V,1W,ADJUSTABLE	Texas Instruments	DCH010505SN7	103739-0005R	edj4-6040	
15	2	Q1, Q2		TRANSISTOR,SOT23,MOSFET,150V,530mA	Vishay Intertechnology	SI2325DS-T1-E3	103825-0001R		
16	1	Q3		TRANSISTOR, SOT23, MOSFET, N CHANNEL	NXP Semiconductors	2N7002E,215	103824-0001R	SOT23-28X44-GSD	
17	6	Q4, Q5, Q6, Q7, Q8, Q9		TRANSISTOR, TO263, MOSFET, 60V, 110A	Vishay Intertechnology	SUM110N06-3M9H-E3	103810-0001R		
18		U10, U11, U12		IC,SO5,OP AMP,1.8V	Texas Instruments	TLV2781IDBVR	103952-0001R	dbv5-27x39	
20	1	D1		DIODE.SMT.SCHOTTKY.2A.100V	Comchip Technology	CDBB2100-G	103820-0001R		
25	5	LED1, LED10, LED11, LED12, LED3		LED,SMT 0805,GREEN	LITEON	LTST-C170KGKT	103827-0002R	led2-47sq	
26		LED6		LED,SMT 0805,SUPER RED	LITEON	LTST-C170KRKT	103827-0001R	led2-47sq	
27		LED5		LED,SMT 0805,YELLOW	LITEON	LTST-C171YKT	103330-0003R		
30	1	11		INDUCTOR,SMT,33uH		DR74-330-R	103135-0331R	dr74-98x126	
40	1	C57	220uF	CAP,ELEC,SMT,220uF,10V	Panasonic	EEE-1AA221XP	103818-0222R	GITT COXTED	
45		C93, C94	330uF	CAP,ELEC,RADIAL,330uF,100V,20%	Nichicon Corporation	UVZ2A331MHD	103819-0332R		+
46		C50	1000uF	CAP,ELEC,RADIAL,300uF,100V,20%	Panasonic	ECA-2AHG102	103817-0103R		+
50	+ +	C11	47uF	CAP,CER,SMT 1210,47uF,16V,X5R,+/-20%		EMK325BJ476MM-T	103815-0471R	c1210-70x102	
51		C6, C7, C81, C82, C83	2.2uF	CAP,CER,SMT 1210,47uF,16V,X5R,+7-20% CAP,CER,SMT 1210,2.2uF,100V,X7R,+/-10%	Taiyo Yuden TDK Corporation	C3225X7R2A225K	103814-0220R	c1210-70x102	
55		C6, C7, C81, C82, C83 C14	2.2uF 2.2uF	CAP,CER,SMT 1210,2.2uF,100V,X7R,+7-10% CAP,CER,SMT 0805,2.2uF,25V,X7R,10%		08053C225KAT2A	101415-0220R		
55	1	C14	Z.ZUF	CAP,CER,SMT 0805,2.20F,25V,X7R,10%	AVX Corporation	08053C225KAT2A	101415-0220R	c805-35x60	
56		C5, C51, C8	0.1uF	CAP,CER,SMT 0805,.1uF,100V,+10/-10%,X7R	Kemet Electronics Corporation		103813-1100R	c805-35x60	
58	1	C1	6800pF	CAP,CER,SMT 0603,6800pF,50V,+/-10%,X7R	Panasonic	ECJ-1VB1H682K	100993-1682R	c603-35x45	
59	1	C2	39pF	CAP,CER,SMT 0603,39pF,50V,+/-5%,NPO	Panasonic	ECJ-1VC1H390J	101002-1394R	c603-35x45	
60	5	C20, C22, C44, C46, C48	2.2uF	CAP,CER,SMT 0603,2.2uF,10V,+/-10%,X7R	Murata Electronics	GRM188R71A225KE15D	102965-0220R	c603-35x45	
61	5	C10, C12, C15, C19, C23	1uF	CAP,CER,SMT 0603,1uF,25V,+/-10%,X5R	Murata Electronics	GRM188R61E105KA12D	103594-0100R	c603-35x45	
62	4	C29, C30, C31, C33	47uF	CAP,CER,SMT 0603,.47uF,25V,+/-10%,X7R	Murata Electronics	GRM188R71E474KA12D	103816-1470R	c603-35x45	
63		C13, C16, C17, C18, C21, C24, C25, C26, C27, C28, C32, C34, C35, C42, C43, C45, C47, C58, C59, C67, C68, C69, C72, C73, C74, C76, C77, C85, C9	0.1uF	CAP.CER.SMT 0603.,1uF,50V,+/-10%,X7R	AVX Corporation	06035C104KAT2A	100993-1100R	c603-35x45	
64	1			CAP.CER.SMT 0603022uF.50V.+/-10%.X7R	Murata Electronics	GRM188R71H223KA01D		c603-35x45	
65	1	C53	0.01uF	CAP.CER.SMT 0603,.01uF.100V.+/-10%,X7R	TDK Corporation	C1608X7R2A103K	102482-1101R	c603-35x45	
66	1		0.015uF	CAP,CER,SMT 0603,.015uF,50V,+/-10%,X7R	Panasonic	ECJ-1VB1H153K	100993-1151R	c603-35x45	
	t	C36, C37, C38, C39, C40, C41, C75, C78,		- ,- ,					
67	12	C79, C80, C84, C98	0.001uF	CAP,CER,SMT 0603,.001uF,50V,+/-10%,X7R	AVX Corporation	06035C102KAT2A	100993-1102R	c603-35x45	
75		R28	10Kohm	POT,12mm SQ,10K,1/8 WATT,SINGLE TURN	CTS Electronics Corporation	296UD103B1N	103811-1003R	00/10	
		R109, R110, R111, R112, R117, R119, R130, R132, R133, R134, R135, R5, R50,							
80	16	R91, R97, R98	0ohm	RES,SMT 0603,0 OHM,1/16 WATT	Panasonic	ERJ-3GEY0R00V	100687-0001R	r603-35X45	
81	7	R66, R67, R68, R69, R70, R71, R8	1ohm	RES,SMT 0603,1 OHM,5%,1/16 WATT	Panasonic	ERJ-3RQJ1R0V	100687-0100R	r603-35X45	
82	1	R87	10ohm	RES,SMT 0603,10 OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF10R0V	100642-1000R	r603-35x45	
84	1	R17	120ohm	RES,SMT 0603,120 OHM,5%,1/16 WATT	Panasonic	ERJ-3GEYJ121V	100687-1201R	r603-35X45	
85	q	R12, R13, R21, R29, R30, R31, R32, R33, R34	1Kohm	RES,SMT 0603,1K OHM,5%,1/16 WATT	Yageo	RC0603JR-071KL	100687-1002R	r603-35X45	
86	1	R49	820ohm	RES,SMT 0603,820 OHM,5%,1/16 WATT	Panasonic	ERJ-3GEYJ821V	100687-8201R	r603-35X45	1
87	4	R20, R22, R23, R26	470ohm	RES.SMT 0603,470 OHM.5%,1/16 WATT		ERJ-3GEYJ471V	100687-4701R	r603-35X45	
88		R14, R15, R18, R24, R27	330ohm	RES,SMT 0603,330 OHM,5%,1/16 WATT	Panasonic	ERJ-3GEYJ331V	100687-3301R	r603-35X45	1
93		R10, R11, R7, R9	10Kohm	RES,SMT 0603,10K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF1002V	100642-1003R	r603-35x45	+
94	1		205Kohm	RES.SMT 0603,10K OHW,1%,1/16 WATT	Panasonic	ERJ-3EKF2053V	100642-1003R 100642-2054R	r603-35x45	1
95	1	R4	28Kohm	RES,SMT 0603,28K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF2802V	100642-2034R 100642-2803R	r603-35x45	+
- 55	÷	R122, R123, R124, R125, R126, R127,	LUNCIIII	11.20,0.1.1 0000,2011 OT 1811,170,1710 W7111		2.10 JEN 2002 V	100072 2000IX	.000 00040	+
96	13	R125, R125, R124, R125, R126, R127, R19, R25, R36, R48, R62, R64, R65	4.99Kohm	RES,SMT 0603,4.99K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF4991V	100642-4992R	r603-35x45	

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97	2	R128, R129	49.9Kohm	RES,SMT 0603,49.9K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF4992V	100642-4993R	r603-35x45	
98		R6	53.6Kohm	RES,SMT 0603,53.6K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF5362V	100642-5363R	r603-35x45	
99	4	R35, R60, R61, R63	95.3Kohm	RES,SMT 0603,95.3K OHM,1%,1/16 WATT	Panasonic	ERJ-3EKF9532V	100642-9533R	r603-35x45	
101	6	R103, R105, R107, R108, R113, R95	20Kohm	RES,SMT 0603,20K OHM, .1%,1/10 WATT	Panasonic	ERA-3AEB203V	103951-2003R	r603-35x45	
102	2	R37, R38	10Kohm	RES,SMT 0603,10K OHM, .1%,1/10 WATT	Panasonic	ERA-3AEB103V	103951-1003R	r603-35x45	
103	6	R99, R101, R104, R92, R94, R102	1Kohm	RES,SMT 0603,1K OHM, .1%,1/10 WATT	Panasonic	ERA-3AEB102V	103951-1002R	r603-35x45	
106	1	R16	1ohm	RES,SMT 1206,1 OHM,5%,1/4 WATT	Panasonic	ERJ-8GEYJ1R0V	100155-0100R	r1206-40x70	
108	1	R39	3.3ohm	RES,SMT 1206,3.3 OHM,5%,1/4 WATT	Panasonic	ERJ-8GEYJ3R3V	100155-0330R	r1206-40x70	
110	3	R80, R81, R82	0.002ohm	RES,SMT 4527,.002 OHM,1%,5W	Vishay Intertechnology	WSR52L000FEA	103809-0002R		
115	2	SW1, SW2		SWITCH,SMT,PUSHBUTTON,MOMENTARY,4mm	Bourns	7914J-1-000E	102984-0001R	sw4-50x70-7914J	
120	2	J25, J26		TERMINAL BLOCK,2 POS., VERT., 15mm SPC., 90A	Molex	39920-0502	103823-0002R		
121	1	J2		TERMINAL BLOCK,2 POS., VERT., 5mm SPC.	On-Shore Technology, Inc.	ED500/2DS	103821-0002R		
122	1	J11		TERMINAL BLOCK,4 POS., VERT., 15mm SPC., 90A	Molex	39920-0504	103823-0004R		
125	1	J1		CONN,100 PIN,DIMM SOCKET,W/EXTRACTORS	Molex	87630-1001	102232-0100R	molex100-71251-5101	
129	6	J12, J13, J23, J24, JP2, JP4		HEADER,2 X 1,VERTICAL,PIN			100115-0002R	JUMP1X2-6040	
130	1	J7		HEADER,3 X 1,VERTICAL,PIN			100115-0003R	JUMP1X3-6040	
133	4	J10, J4, J6, J8		HEADER,5 X 1,VERTICAL,PIN			100115-0005R	JUMP1X5-6040	
134	1	J20		HEADER,5 X 2, VERTICAL, PIN	Oupiin	2011-2X05G00SB/SN	100116-0005R	JUMP2X5-6040	
135	1	J21		HEADER,7 X 2,VERTICAL,PIN	Oupiin	2011-2X07G00SB/SN	100116-0007R	JUMP2X7-6040	
136	1	J5		HEADER,20 X 2, VERTICAL, PIN			100116-0020R	conn40-5638	
145	10	TP12, TP13, TP14, TP16, TP17, TP19, TP23, TP24, TP25, TP3		TEST POINT, ORANGE	Keystone Electronics Corp.	5003	103020-5003R		
146	4	TP11, TP4, TP5, TP6		TEST POINT,RED	Keystone Electronics Corp.	5000	103020-5000R		
147	5	TP10, TP20, TP7, TP8, TP9		TEST POINT,BLACK	Keystone Electronics Corp.	5001	103020-5001R		
150	2	JP2, JP4		JUMPER,SHUNT,2 POS	Sullins Electronics, Corp.	SPC02SYAN	100123-0001R		
151	8	XMH1, XMH2, XMH3, XMH4, XMH5, XMH6, XMH7, XMH8		SCREW,PHILLIPS,PAN,SS,4-40 X .250	Above Board Electronics,Inc.	0440X0250PNPHSSPS	100329-0250R		
152		XXMH1, XXMH2, XXMH3, XXMH4, XXMH5, XXMH6, XXMH7, XXMH8		SPACER,ROUND,ALUM,4-40,.187 O.D. X .875L	Keystone Electronics Corp.	2030	103812-0875R		
155		C52, C86, C87, C88, C95, C96, C97		_			C0603-NOPOP	c603-35x45	No pop
160	10	R2, R3, R40, R41, R42, R43, R44, R45, R46, R47					R0603-NOPOP	r603-35X45	No pop
170		D2					NO-POP		No pop
200	6	TP1, TP15, TP18, TP2, TP21, TP22					TP-27SQ15-NO-POP		No pop

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